CMOS LSI

LC80101M

VICS LSI



Overview

The LC80101M is a special-purpose descrambler LSI for use in VICS systems. FM multiplexed service data that has had VICS center scrambling applied can be descrambled and received by inserting this LSI in the serial interface between the LC72700E and the application CPU. This architecture also supports reception of regular transmissions that have not been scrambled. Note that sample evaluation and product manufacture using this LSI require a contract with the VICS Center organization.

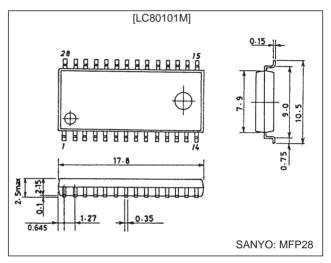
Functions

- VICS scrambled/unscrambled recognition circuit
- Dedicated VICS descrambler circuit
- CPU interface circuit (CCB: serial)

Package Dimensions

unit: mm

3091A-MFP28



Specifications Absolute Maximum Ratings

Parameter	Symbol	Conditions Ratings		Unit
Maximum supply voltage	V _{DD} max	V _{DD}	-0.3 to +7.0	V
	V _{IN} 1	The CL2, CE2, DI2, RST2, BACKUP, INT-R1, and DI1 pins	-0.3 to +7.0	V
Input voltage	V _{IN} 2	Input pins other than V _{IN} 1	–0.3 to V _{DD} +0.3	V
Output welterer	V _{OUT} 1	The DO2 pin	-0.3 to +7.0	V
Output voltage	V _{OUT} 2	Output pins other than VOUT1	–0.3 to V _{DD} +0.3	V
Allowable power dissipation	Pdmax	Ta ≤ 85°C	200	mW
Operating temperature	Topr		-40 to +85	°C
Storage temperature	Tstg		-55 to +125	°C

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- CCB is SANYO's original bus format and all the bus
- addresses are controlled by SANYO.

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Serial Input and Output	(See the serial data	timing figures.)
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Parameter	Symbol	Conditions	Ratings			Unit
Falametei	Parameter Symbol Conditions	min	typ	max	Unit	
Clock low-level time	t _{CL}	CL2	0.7			μs
Clock high-level time	tсн	CL2	0.7			μs
Data setup time	t _{SU}	CL2, DI2	0.7			μs
Data hold time	t _{HD}	CL2, DI2	0.7			μs
CE wait time	t _{EL}	CL2, CE2	0.7			μs
CE setup time	t _{ES}	CL2, CE2	0.7			μs
CE hold time	t _{EH}	CL2, CE2	0.7			μs
Data output time	t _{DH}	DO2: Varies with the value of the pull-up resistor used			1	μs

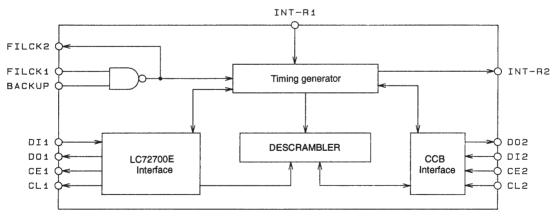
Electrical Characteristics/Input and Output Levels at Ta = -40 to +85 $^{\circ}C,$ V_{DD} = 4.5 to 5.5 V, V_{SS} = 0 V

Parameter	Cumhal	Conditions	Ratings			Linit
Parameter	Symbol	Conditions	min	typ	max	Unit
Input high-level voltage	VIH	CMOS-compatible Schmitt inputs	0.8 V _{DD}			V
Input low-level voltage	VIL	Pull-down resistors: INT-R1, TEST1 to TEST4, and TESTON			0.2 V _{DD}	V
Input high-level voltage	VIH	CMOS-compatible Schmitt inputs:	0.8 V _{DD}			V
Input low-level voltage	VIL	BACKUP, CE2, CL2, DI1, DI2, and RST2			0.2 V _{DD}	V
Output high-level voltage	V _{OH}	I _{OH} = -4 mA: CE1, CL1, DO1, INT-R2	V _{DD} – 2.1			V
Output low-level voltage	V _{OL}	I _{OL} = 4 mA: CE1, CL1, DO1, INT-R2			0.4	V
Output low-level voltage	V _{OL}	I _{OL} = 2 mA: DO2			0.4	V
Standby current	Isd	With the BACKUP pin low		0.01	10	μA
Input sensitivity	Vck	Rf = 1 M Ω , FILCK1 = 3.6 MHz: FILCK1*1	1.0		V _{DD}	Vp-p
Pull-down resistance	Rd	INT-R1, TEST1 to 4, TESTON	70	140	280	kΩ
	I _{DD} 1	Sine wave input: 1 V p-p, V _{DD} = 5.0 V*2		6	15	mA
Current drain	I _{DD} 2	Sine wave input: 5 V p-p, V _{DD} = 5.0 V*2		2.5	7	mA
	I _{DD} 3	Square wave input: 1 V p-p, V _{DD} = 5.0 V*2		5	13	mA
	I _{DD} 4	Square wave input: 5 V p-p, V _{DD} = 5.0 V*2		1.5	4	mA

Note 1. Since this LSI operates based on the rising edge of the LC72700E 3.6 MHz output (the FILCK pin), the LC72700E 3.6 MHz output signal must be input to the FILCK1 pin without inverting the polarity.

2. The current drain varies with the input level and the shape of the clock signal input to the FILCK1 pin. The current drain can be reduced by using waveforms that are closer to square waves than to sine waves, and by using a signal level that is close to V_{DD}. The LC72700E 3.6 MHz output is a square wave with an output level equal to V_{DD}.

Block Diagram

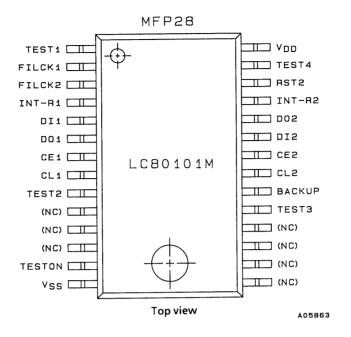


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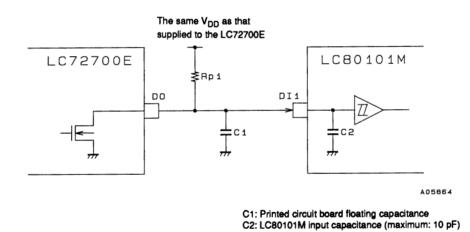
Pin Assignments and Functions

Pin No.	Pin	Function overview	Input or output circuit type
	TEST1	Test pin 1 (Must be connected to ground or left open in normal operation.)	
1	TEST2	Test pin 2 (Must be connected to ground or left open in normal operation.)	
9	TEST3	Test pin 3 (Must be connected to ground or left open in normal operation.)	
19	TEST4	Test pin 4 (Must be connected to ground or left open in normal operation.)	L ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓
27	TESTON	Test pin (Must be connected to ground in normal operation.)	
13		Rd: Input pin internal pull-down resistor	777 A05857
5	DI1	Inputs the output of the LC72700E pin 32. An external pull-down resistor is required. See the following page.	
20	BACKUP	Input that selects normal operation when high and backup mode when low.	
21	CL2	Clock input for the CCB serial interface	
22	CE2	Control input for the CCB serial interface	
23	DI2	Data input for the CCB serial interface	A05658
26	RST2	System reset input (negative logic)	
4	INT-R1	Inputs the output of the LC72700E pin 35. Rd: Input pin internal pull-down resistor	
			₹Rd ,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,
6	DO1	Output to the LC72700E pin 31 input	
7	CE1	Output to the LC72700E pin 30 input	
8	CL1	Output to the LC72700E pin 29 input	
25	INT-R2	Outputs an output data interrupt to the external CPU	A05860
24	DO2	Data output for the CCB serial interface	
2	FILCK1	System clock generator input	
3	FICLK2	System clock generator output	
		Rf: External feedback resistor, 510 k Ω to 1.5 M Ω (typical: 1 M Ω)	Rf\$
28	V _{DD}	Power supply (+4.5 to 5.5 V)	
14	V _{SS}	Ground connection	
10, 11,	NC	No connection pins. These pins must be left open.	
12, 15,			
16, 17			
18			

Pin Assignment



Notes on the pull-up resistor used between the LC72700E pin 32 (DO) and this LSI's pin 5 (DI1)



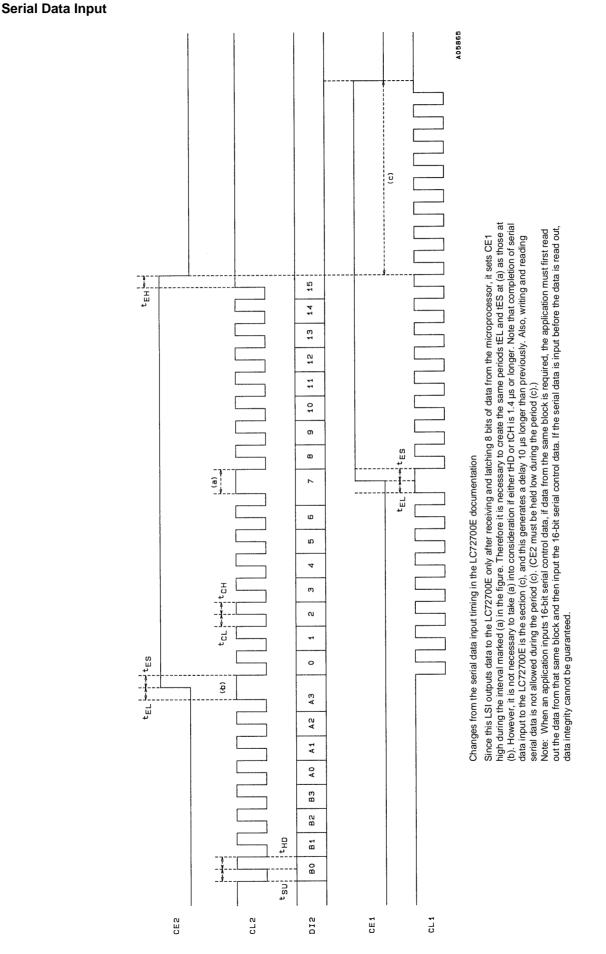
The value of the pull-up resistor Rp1 must be determined based on the printed circuit board's floating capacitance and the LC80101M's clock. The time t_{CL} for the LC80101M clock is 1.1 µs (corresponding to 450 kHz). This clock is used as the readout clock output to the LC72700E during the period discussed in note 1 for the basic timing of the external interface as discussed on page 7. If the t_{CL} of the CL2 clock from the microprocessor is longer than the t_{CL} of the LC80101M clock, a t_{CL} of 1.1 µs must be used in the formulas below. If the t_{CL} of that clock is shorter than that of the LC80101M clock, then the t_{CL} of CL2 must be substituted in the formulas below.

For example, in the configuration shown in the figure above, assuming the t_{CL} of CL2 is 1.0 µs (i.e. CL2 = 500 kHz), then: $T = t_{CL} - 555$ ns (the LC72700E data output time)

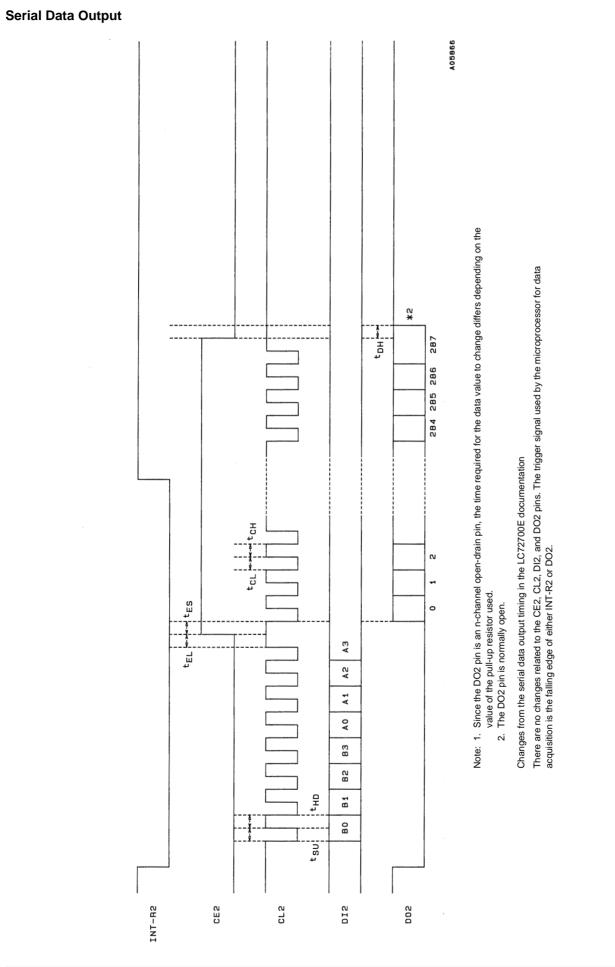
Since $T \approx 2.2 (C1 + C2) R$

$$Rp1 \approx \frac{445 \text{ ns}}{2.2 (C1 + C2)}$$

Assuming that C1 = 10 pF and C2 = 10 pF, then Rp1 will be $\leq 10.1 \text{ k}\Omega$. These considerations must be used as guidelines when determining the value of the pull-up resistor Rp1.



LC80101M



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External Interface Basic Timing

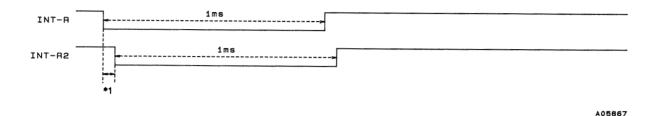


Figure 1

Figure 1 shows how the timing changes between the LC72700E INT-R output and this LSI's INT-R2 output. This LSI requires the period indicated as "Note 1", about 160 µs, following the detection of a falling edge on the INT-R signal to set up the descrambling processing. It outputs a falling edge on INT-R2 after the note 1 time has elapsed. Serial data reads and writes are disabled during this period.

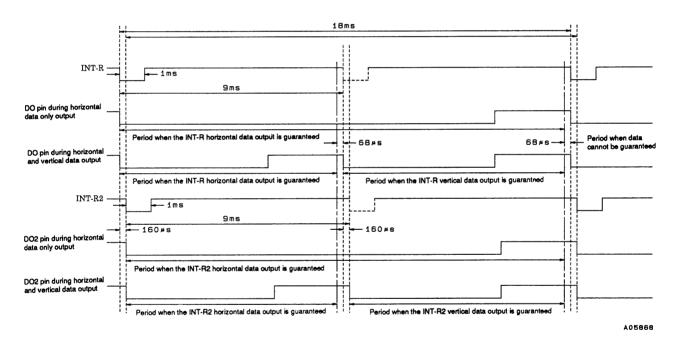


Figure 2

Figure 2 shows the basic timing for the external interface. When this LSI is not used and the system is operated based on the INT-R trigger, if only horizontal data is output, there will be a data readout guaranteed period of 18 - 0.068 = 17.932 ms, and if both horizontal and vertical data are read out, there will be two 9 - 0.068 = 8.932 ms data readout guaranteed periods, one each for horizontal and vertical data output. When this LSI is used and the system is operated based on the INT-R2 trigger, these data readout guaranteed periods are shortened by exactly the amount the INT-R2 signal is delayed, namely 160 µs. When only horizontal data is output, the data readout guaranteed period will be 17.932 - 0.160 = 17.772 ms, and both horizontal and vertical data is output, the data readout guaranteed periods will be 8.932 - 0.160 = 8.772 ms for both horizontal and vertical data output.

Usage Notes

- Setting the BACKUP pin low switches the LC80101M to backup mode. This is a mode in which oscillator and chip operation are stopped to reduce current drain. This pin must be set high for normal operation. Also note that a reset must be applied after the BACKUP pin is returned to high from low. (See Figure 4 on page 8.) The BACKUP pin must be connected to the LC80101M V_{DD} pin if backup mode is not used.
- 2. The lines connecting this LSI to the LC72700E must be dedicated lines only used by these two chips. Do not connect these lines to any other circuits via a bus or any other connection.
- 3. A reset must be applied when power is first applied. The LC72700E RST pin and this LSI's RST2 pin can be driven from a common signal. (See Figure 3 on page 8.)
- 4. The TESTON pin (pin 13) must be connected to ground.

Operation During Reset

A reset signal is applied by setting the RST2 pin input level below V_{IL} for at least 300 ns when the power-supply voltage (V_{DD}) is 3.4 V or higher. See Figure 3.

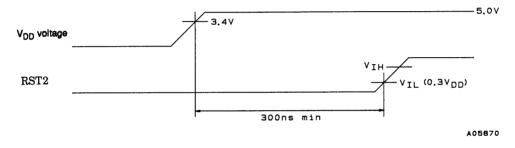
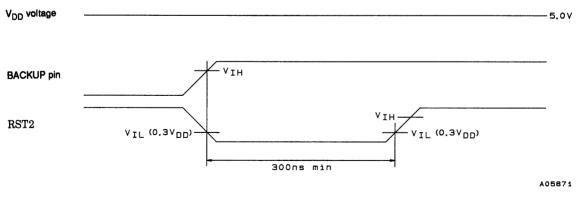


Figure 3

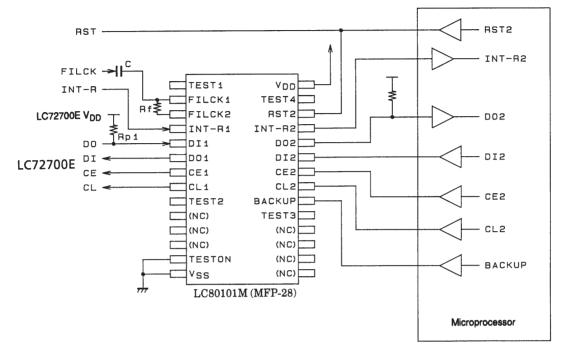
All registers other than those holding data required for descrambling are reset by a reset signal. The crystal oscillator circuit does not stop.

BACKUP Pin

A reset must be applied after the BACKUP pin is returned to high (for normal operation from low (backup mode, in which the oscillator is stopped). See the following figure.







Sample Circuit Connecting the LC80101M, the LC72700E, and a Microprocessor

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